National Semiconductor

NS486™SXF Optimized 32-Bit 486-Class Controller with On-Chip Peripherals for Embedded Systems

General Description

The NS486SXF is a highly integrated embedded system controller incorporating an Intel486™-class 32-bit processor, all of the necessary System Service Elements, and a set of peripheral I/O controllers tailored for embedded control systems. It is ideally suited for a wide variety of applications running in a segmented protect-mode environment.

Key Features

- 100% compatible with VxWorks[®], VRTX[®], QNX[®], pSOS+[™], and other popular real-time executives and operating system kernels
- Intel486 instruction set compatible (protected mode only) with optimized performance
- Operation at 25 MHz with 5V supply
- Low cost 160-pin PQFP package
- Industry standard interrupt controller, timers, real time clock, UART with IrDA v1.0 (Infrared Data Association) port

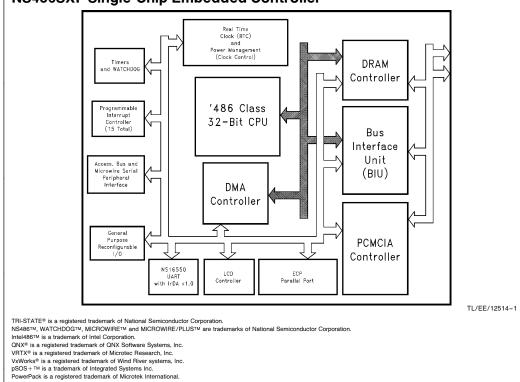
- Intel 82365 compatible PCMCIA interface
- Protected WATCHDOG™ timer
- Optimized DRAM controller (Supports two banks, up to 8 MBytes each)

ADVANCE INFORMATION

September 1995

- Up to nine versatile, programmable chip selects
- Glueless interface ISA-type peripherals
- Arbitration support for auxiliary processor
- Four external DMA channels (max. transfer rate of 25 MByte/sec @ 25 MHz) support many transfer modes
- High performance IEEE 1284 (ECP) Bidirectional Parallel Port
- MICROWIRETM/MICROWIRE/PLUSTM/Access.bus synchronous serial interfaces
- LCD Controller for monochrome supertwist Liquid Crystal Displays up to 480 x 320
- Reconfigurable I/O: Up to 29 I/O pins can be used as general purpose bidirectional I/O lines
- Flexible, programmable, multilevel power saving modes maximize power savings

NS486SXF Single-Chip Embedded Controller



© 1995 National Semiconductor Corporation TL/EE12514

RRD-B30M125/Printed in U. S. A.

Table of Contents

- **1.0 SYSTEM OVERVIEW**
- 1.1 NS486SXF System Overview
- 1.2 32-Bit Processor Core
- 1.3 System Service Elements
 - 1.3.1 DRAM Controller
 - 1.3.2 DMA Controller
 - 1.3.3 Programmable Interval Timer
 - 1.3.4 WATCHDOG Timer
 - 1.3.5 Interrupt Controller
 - 1.5.5 Interrupt Controller
 - 1.3.6 Real Time Clock/Calendar
 - 1.3.7 Power Management Features
- 1.4 NS486SXF System Bus
- 1.5 Other On-Board Peripherals
 - 1.5.1 Reconfigurable I/O Lines
 - 1.5.2 IEEE 1284 Bidirectional Port
 - 1.5.3 PCMCIA Interface
 - 1.5.4 MICROWIRE/Access.bus Interface
 - 1.5.5 UART Serial Port
 - 1.5.6 LCD Controller
- 1.6 ICE Support
- 1.1 Other Issues

2.0 PIN DESCRIPTION TABLES TABLE 2-1. Bus Interface Unit Pins TABLE 2-2. DMA Control Pins TABLE 2-3. DRAM Control Pins TABLE 2-4. Power Pins TABLE 2-5. Reset Logic Pins TABLE 2-6. Auxiliary Processor Interface Pins TABLE 2-7. Test Pins TABLE 2-8. Interrupt Control Pins TABLE 2-9. Real Time Clock Pins TABLE 2-10. LCD Interface Pins TABLE 2-11. Oscillator Pins TABLE 2-12. IrDA/UART Pins TABLE 2-13. PCMCIA Pins TABLE 2-14. IEEE-1284 Port (ECP Mode) TABLE 2-15. Timer Pins TABLE 2-16. 3-Wire Serial I/O Pins TABLE 2-17. General Purpose Chip Select Pins TABLE 2-18. Summary of Reconfigurable I/O Pins

1.0 System Overview

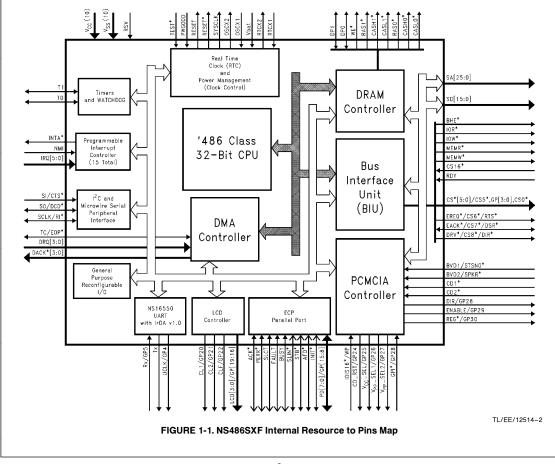
1.1 NS486SXF SYSTEM OVERVIEW

The **NS486SXF** is a highly integrated embedded system controller. It includes an Intel486-class 32-bit processor, all resources required for the System Service Elements of a Real-Time Executive, and a generous set of peripherals. This "system-on-a-chip" is ideal for implementing a wide variety of embedded applications. These include (but are not limited to) fax machines, multifunction peripherals (fax, scanners, printers) mobile companions (both organizer and communicator), television set-top boxes, and telephones (mobile and desktop).

The 32-bit processor core executes all of the Intel486 instructions with a similar number of clocks per instruction. An on-board 1 kbyte instruction cache provides for efficient execution from ROM. Intel486 debug features are supported. The processor has been optimized for operating system kernels such as VRTX, VxWorks, pSOS + and QNX. These environments only need the '486 protected mode operation (no real mode or virtual 8086 support), flat or linear memory addressing (no virtual memory paging), and floating point execution in software only (no co-processor interface).

In fact, the **NS486SXF** includes all of the System Service Elements required by a typical kernel, including an efficient DRAM controller that supports page-mode DRAMs for data cache-like performance; a six channel DMA controller with two channels supporting data transfers from on-chip peripherals (the IEEE 1284 ECP or Extended Capabilities Port, and the LCD controller), and four channels supporting external devices such as scanners, and print engines; three timer channels (including one configured as a protected WATCH-DOG Timer); two programmable 8259 interrupt controllers for 15 on-chip interrupt sources; an industry standard real time clock and calendar (RTC) with battery backup; and support for comprehensive power management schemes.

In addition, the **NS486SXF** also incorporates the key I/O peripherals required for implementing a wide variety of embedded applications: an IEEE 1284 Bidirectional Parallel Port that includes both Host and Slave modes, an Intel 82365-compatible PCMCIA controller for one card slot, an industry standard high-performance NS16550-compatible UART with HP-SIR and IrDA v1.0 infrared option, an LCD panel interface with DMA supported refresh for many of the standard resolutions, an 8254 timer, and a general purpose 2- or 3-wire synchronous serial interface for easy interface to low-cost EEPROMs and other serial peripherals. System expansion is supported with nine programmable Chip Select (CS) signals and a generic ISA-type bus interface for external devices and memory.



1.0 System Overview (Continued)

Certain I/O lines not being used by disabled peripherals can be reconfigured for use as general purpose bidirectional I/O lines (up to 29 pins). This gives the designer maximum flexibility in designing various systems using the **NS486SXF** device. It is expected that an **NS486SXF** system will minimally include the **NS486SXF** system controller with on-board processor and I/O devices, boot ROM, and working RAM memory. Many applications will not require any additional I/O support.

Finally, the **NS486SXF** implements a very flexible power management scheme that permits selective control of individual I/O subsystems, with varying levels of power consumption.

NS486SXF provides a cost-effective hardware platform for the design and implementation of a wide range of office automation and communication systems. With its powerful embedded '486-class processor, comprehensive set of onchip peripheral controllers, flexible power management structure and reconfigurable I/O lines, **NS486SXF** makes possible a variety of end-user systems based on the same hardware. Because of its optimized design and on-board resources, a very cost effective system can be achieved.

1.2 32-BIT PROCESSOR CORE

The **NS486SXF** processor core is an implementation of the protected mode '486 instruction set architecture, optimized using a RISC-like design philosophy for embedded applications. Using this approach, the most frequently used instructions are optimized, and on an average execute in a lower number of clock cycles than a '486.

The NS486SXF features a three stage pipeline, efficient instruction prefetching mechanism, and single cycle instruction decoding for most instructions. Additionally, a 1 kbyte instruction cache and single cycle DRAM access provide higher memory performance than a larger unified cache implementation while requiring much less die area.

The **NS486SXF** processor provides the same programming model and register set as the standard '486 except that real mode, virtual memory, and floating point support have been eliminated. These features have little or no impact in embedded applications and save significant silicon real estate. At reset, unlike the standard '486, the **NS486SXF** starts up in protected mode instead of real mode. All '486 instructions appropriate to protected mode and our hardware configuration are supported, including debug instructions.

The **NS486SXF** is initially available to run 25 MHz at 5V. The processor clock is obtained by dividing the crystal frequency by two. For example, a 25 MHz **NS486SXF** runs with a 50 MHz crystal oscillator as the master clock.

As a result of our innovative design, the **NS486SXF** achieves performance equivalent to a standard '486 with a much smaller die area. This translates into reduced power consumption and a lower overall system cost. It also makes the **NS486SXF** ideal for "green" systems and battery operated systems.

1.3 SYSTEM SERVICE ELEMENTS

The **NS486SXF** controller provides the basic hardware resources required for the O/S-defined System Service Elements. These include a DRAM controller, a DMA controller, programmable interval timer, a protected WATCHDOG timer, a programmable interrupt controller, a real-time clock and calendar, and comprehensive power management features.

1.3.1 DRAM Controller

The **NS486SXF** DRAM controller supports one or two adjustable-sized banks of dynamic RAM using a 16-bit data path. Support is provided for byte parity (if desired), requiring the DRAM banks to be 18 bits wide when parity is enabled. Banks can be up to 8 Mbytes in size. The DRAM controller supports page mode read and write operations and can also support both byte and word accesses. All access control signals for read, write and parity checking are generated as well as an automatic and programmable CASbefore-RAS refresh. If self-refresh DRAMs are used, refresh can be disabled, saving power.

NS486SXF provides flexible support for use of a number of different DRAM configurations, using popular DRAM devices. Access is optimized for fast page mode DRAMs, and they will provide the highest performance with contiguous data. When accessing data bytes or words in the same DRAM page, the data access is in one cycle. This performance provides fast data access times without the overhead of a separate data cache. Page sizes can be 256, 512, 1024 or 2048 bytes. Flexibility for DRAM timing is provided through programming of the DRAM controller registers: 3 or 4 cycle page miss accesses and extended CAS cycles can be selected.

Memory bank 0 starts at address 0h; memory bank 1 can start at any address in the 128 Mbyte address map that is a multiple of its size.

1.3.2 DMA Controller

The NS486SXF Direct Memory Access (DMA) controller is a high speed 16-bit controller that improves system performance by off-loading from the processor the task of managing data transfers to and from memory and external devices. Data transfers are done independently from the processor at a maximum data rate of 2 bytes per 2 clock cycles. (A 25 MHz clock yields a 25 Mbyte per second transfer rate.) There are six independent DMA channels. Requestor and target addresses have a maximum addressable memory range of 64 Mbytes. Three standard transfer modes, single, block and demand, are provided giving the designer a wide range of DMA options. A special transfer type, cascademaster, allows an external master to access the NS486SXF ISA-like bus. Normal transfers can be from memory to memory, memory to I/O and I/O to memory. DMA transfers are controlled by DMA control registers in the NS486SXF control register I/O map.

1.3.3 Programmable Interval Timer

The **NS486SXF** programmable interval timer is compatible with the Intel 8254 programmable interval timer and contains three identical timers (CH0–CH2). CH0 and CH1 can be used to generate accurate timing delays under software control. CH2 may be configured to provide a WATCHDOG timer function.

1.3.4 WATCHDOG Timer

The **NS486SXF** WATCHDOG timer, CH2, is a protected 16bit timer that can be used to prevent system "lockups or hangups." It uses a 1 kHz clock generated by the on-chip real-time clock circuit. If the WATCHDOG timer is enabled and times out, a reset or interrupt will be generated allowing graceful recovery from an unexpected system lockup.

1.0 System Overview (Continued)

1.3.5 Interrupt Controller

The NS486SXF interrupt controller consists of two cascaded programmable interrupt controllers that are compatible with the Intel 8259A Programmable Interrupt Controller. They provide a total of 15 (out of 16) programmable interrupts. Three interrupts are reserved for a real time clock-tick interrupt, a real time clock interrupt request, and a cascade interrupt channel. The remaining 13 interrupts can be used by internal or external sources. Additional external interrupt controllers can be cascaded as well.

1.3.6 Real Time Clock/Calendar

The **NS486SXF** Real Time Clock/Calendar is a low power clock that provides a time-of-day clock and 100-year calendar with alarm features and battery operation. Time is kept in BCD or binary format. It includes 50 bytes of general purpose CMOS RAM and 3 maskable interrupt sources. It is compatible with the DS1287 and MC146818 RTC/Calendar devices, except for the general purpose memory size.

1.3.7 Power Management Features

The NS486SXF power management structure includes a number of power saving mechanisms that can be combined to achieve comprehensive power savings under a variety of system conditions. First of all, the core processor power consumption can be controlled by varying the processor? system clock frequency. The internal CPU clock can be divided by 4, 8, 16, 32 or 64. In addition, in idle mode, the internal processor clock will be disabled. Finally, if an external crystal oscillator circuit is being used, it can be disabled. For maximum power savings, all internal clocks can be disabled (except for the real-time clock oscillator).

Some peripherals, notably the timer and the PCMCIA interface, can be switched between a fixed frequency (external oscillator/2) and the CPU clock. If the CPU clock is being divided down, running these peripherals from the CPU clock will reduce their power consumption as well. The clocks of other on-board peripherals can be individually or globally controlled. By setting bits in the power management control registers, the internal clocks to the DMA controller, the ECP port, the three-wire interface, the timer, the LCD controller, the DRAM controller, the PCMCIA controller and the UART can be disabled.

In addition to these internal clocks, the external SYSCLK can be disabled via a bit in the power management control registers.

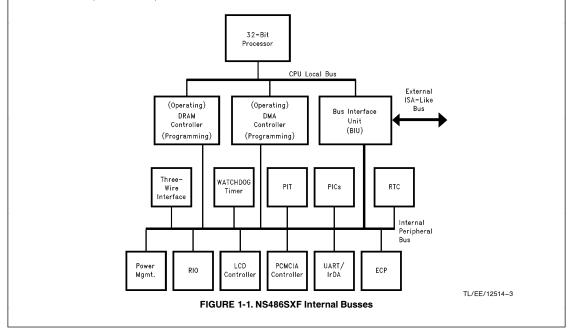
Using various combinations of these power saving controls with the **NS486SXF** controller will result in excellent programmable power management for any application.

1.4 NS486SXF SYSTEM BUS

The NS486SXF system bus provides the interface to offchip peripherals and memory. It offers an ISA-compatible interface and is therefore capable of directly interfacing to many ISA peripheral control devices. The interface is accomplished through the Bus Interface Unit or BIU. The BIU generates all of the access signals for both internal and external peripherals and memory. Depending upon whether the access is to internal peripherals, external peripherals or external memory, the BIU generates the timing and control signals to access those resources. The BIU is designed to support a glueless interface to many ISA-type peripherals.

For debug purposes, the **NS486SXF** can be set to generate external bus cycles at the same time as an internal peripheral access takes place. This gives logic analyzers or other debug tools the ability to track and capture internal peripheral accesses.

Access to internal peripherals is accomplished in three CPU T-states (clock cycles). The fastest access to off-chip I/O is also three T-states. When accessing off-chip memory and I/O, wait state generation is accomplished through a combination of **NS486SXF** chip select logic and off-chip peripheral control signals.



1.0 System Overview (Continued)

When the CPU is in idle mode, the BIU is designed to mimic the CPU during DMA interchanges between memory and peripherals. By responding to DRQs and generating DACKs, HOLDs and HOLDAs signals as required, the BIU eliminates the need to reactivate the CPU during such transfers as screen updates from memory to the LCD controller. This gives the designer added flexibility in conserving power while maintaining basic system functions.

1.5 OTHER ON-BOARD PERIPHERALS

In addition to those peripherals and system control elements needed for System Service Elements, the **NS486SXF** also includes a number of I/O controllers and resources that make implementing a complete embedded system possible with just a single-chip **NS486SXF** controller. These include an IEEE 1284 Extended Capabilities Port, a serial UART port, a LCD controller, a PCMCIA interface and a MICROWIRE or Access.bus synchronous serial bus interface. In addition, unused I/O controllers free up their I/O pins for general purpose use.

1.5.1 Reconfigurable I/O Lines

The **NS486SXF** supports reconfigurable I/O. For example, if the UART, ECP Parallel Port, LCD or PCMCIA functions are not being used, the I/O pins associated with them can be reconfigured as general purpose bidirectional I/O pins. Up to 29 pins, on a pin-by-pin basis can be reconfigured for this purpose. This capability makes the **NS486SXF** extremely versatile and ideal for supporting different end product configurations with a single **NS486SXF** device.

1.5.2 IEEE 1284 Bidirectional Port

The **NS486SXF** parallel port is a multifunction 8-bit parallel port that is compatible with the IEEE 1284 bidirectional parallel port standard. The operation of the parallel port is set by the content of the **NS486SXF** parallel port I/O control registers. The port can operate in one of two modes: a standard parallel port mode (PC compatible), or a full Extended Capabilities Port (ECP) mode. The **NS486SXF** ECP port can support both Host and Slave ECP mode. In slave mode, the **NS486SXF** becomes a versatile microprocessor for parallel I/O peripheral devices.

1.5.3 PCMCIA Interface

The **NS486SXF** PCMCIA interface supports the direct connection of a single PCMCIA 2.0 IC card. Exchange Card Architecture (ExCA release 1.50) compatibility and eXecute In Place (XIP) capability is also provided.

Accessing the PCMCIA interface switches the external bus automatically into the PCMCIA mode and permits Memory Window Mapping and Address Offset to be handled inside the **NS486SXF** device. Power management and "hot" card insertion/removal options can be implemented using external buffering, if required.

1.5.4 MICROWIRE/Access.bus Interface

The **NS486SXF** MICROWIRE/Access.bus interface provides for full support of either the three-wire MICROWIRE/ MICROWIRE/PLUS or the two-wire Access.bus serial interfaces. MICROWIRE/PLUS includes all the capabilities of the MICROWIRE standard and adds an alternate clock phasing option that supports the SPI bus protocol as well. These industry standard interfaces permit easy interfacing to a wide range of low-cost specialty memories and I/O devices. These include EEPROMs, SRAMs, timers, clock chips, A/D converters, D/A converters, and peripheral device drivers.

1.5.5 UART Serial Port

The NS486SXF UART provides complete NS16550 (PC standard) serial communications port compatibility including the performance enhancing 16-byte deep FIFO. It performs serial-to-parallel conversion from external devices to the NS486SXF and parallel-to-serial conversion from the NS486SXF to external peripherals. Full modem control can be supported.

A serial IrDA v1.0 and HP-SIR (infrared) mode is also supported, making possible low-cost wireless communications between an **NS486SXF**-based system and other wireless infrared systems.

1.5.6 LCD Controller

The **NS486SXF** LCD controller is capable of controlling a variety of monochrome supertwist LCD configurations including 320x240, 320x200 and 480x320 B&W or grayscale graphics LCD modules equipped with self-contained screen drivers. It uses a video frame buffer in system DRAM with either a 1-bit or 2-bit per pixel grayscale. A 60 Hz to 90 Hz frame refresh rate is supported. Special controls permit the fine tuning of display characteristics to precisely optimize visual display quality.

1.6 ICE SUPPORT

National Semiconductor has worked closely with Microtek International to provide hardware in-circuit emulator support for the **NS486SXF**. The Microtek product (PowerPack® EA-NS486) uses a special bondout version of the **NS486SXF** to deliver a full-featured hardware emulator that is capable of tracing on chip activity, including peripheral interrupt and I/O activity. The emulator runs at full speed, and supports overlay memory and multiple triggers.

1.7 OTHER ISSUES

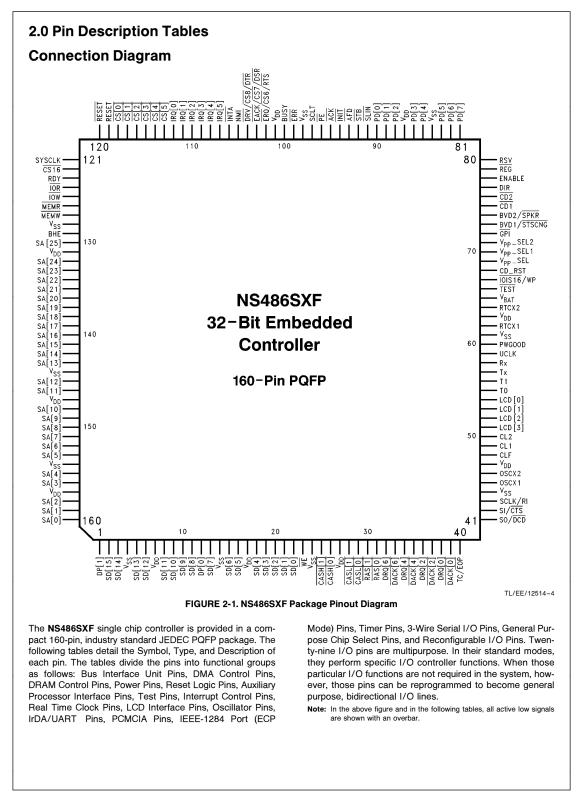
NS486SXF provides a comprehensive set of on-board peripherals. However, it is designed to easily interface to external peripherals as well. In addition to an ISA-like bus for connecting to ISA-compatible peripherals, it supports an interface to an external master with a shared memory space. The external master or auxiliary processor interface allows low cost interfacing to shared external memory belonging to other external masters (including another **NS486SXF** controller).

To program the resources of the **NS486SXF**, a set of control registers exists in the external I/O map. These registers provide precise control over all internal resources and the setup of external **NS486SXF** control signals. It is the designer's responsibility to ensure the proper initialization of the registers in this I/O map.

In addition, the **NS486SXF** core processor itself requires several descriptor tables and initialization parameters that must be set by user-written start-up software.

The **NS486SXF** is designed from the ground up for optimum price/performance in embedded systems. This makes the **NS486SXF** the logical choice as the base hardware platform for executing an embedded operating system kernel such as those available from Microtec, Wind River, ISI, QNX, and many others. Any Operating System or Real-Time Executive that will operate in a segmented or flat memory model protect mode environment is a suitable complement to the **NS486SXF**.

Also, there are many third party tool sets that will allow an executable application to be built to run directly on the target hardware without an O/S environment.



Symbol Pins Type Function SA[25:0] 26 30 System Address bus: These output-only signals carry the latched address for the current access. DRAM accesses multiplex the row and column addresses for the DRAMs on the SA[12:1] pins. During interrupt Acknowledge cycles, the internum laster interrupt controller's cascade line signals, CAS[20] are driven onto SA[25:23] respectively. SD[15:0] 16 1/0 System Data bus: This bi-directional data bus provides the data path for all memory and I/O accesses puring transferred. External 16-bit devices, the upper data byte is not used (SD[15:8)). BHE 1 0. Byte High Enable: This active-low signal indicates that the high byte (odd address byte) is being transferred. External 16-bit devices should use this signal to help them determine that a data byte is to be transferred. External 16-bit devices should use this signal to help them determine that a data byte is to be transferred. This active-low signal instructs an I/O device to place data onto the system data bus. IOR 1 0. IO Read command: This active-low signal indicates to an I/O device that a write operation is in process on the system bus. MEMM 1 0. MEMory Write command: This active-low signal indicates to a memory mapped device to place data onto the system bus. CS16 1 1. Chip Select 16-bit: This active-low signal indicates that the device being accessed is a 16-bit device. This signal should be driven by external device with an open collector					TABLE 2-1. Bus Interface Unit Pins				
DRAM accesses multiplex the row and column addresses for the DRAMs on the SA[12:1] pins. During Interrupt Acknowledge cycles, the internal master interrupt controller's cascade line signals, CAS[2:0] are driven onto SA[25:2] respectively. SD[15:0] 16 I/O System Data bus: This bi-directional data bus provides the data path for all memory and I/O accesses During transfers with 8-bit devices, the upper data byte is not used (SD[15:8]). BHE 1 O Byte High Enable: This active-low signal indicates that the high byte (odd address byte) is being transferred. External 16-bit devices should use this signal to help them determine that a data byte is to be transferred on the upper byte or the System Data bus (SD[15:8]). IOR 1 O Byte High Enable: This active-low signal indicates to an I/O device to place data onto the system data bus. IOW 1 O IO Read command: This active-low signal indicates to an I/O device that a write operation is in process on the system bus. MEMR 1 O MEMory Read command: This active-low signal indicates to a memory mapped device to place data onto the system bus. MEMR 1 O MEMory Write command: This active-low feedback signal indicates that the device being accessed is a 16-bit device. This signal should be driven by external devices with an open collector or TRI-STATE® driver. RDY 1 1 ReaDY: An external device may drive this signal inactive low to insert wait states and extend the ex	Symbol	Pins	Туре		Function				
During transfers with 8-bit devices, the upper data byte is not used (SD[15:8]). BHE 1 O Byte High Enable: This active-low signal indicates that the high byte (odd address byte) is being transferred. External 16-bit devices should use this signal to help them determine that a data byte is to be transferred on the upper byte or the System Data bus (SD[15:8]). IOR 1 O IO Read command: This active-low signal instructs an I/O device to place data onto the system data bus. IOW 1 O IO Write command: This active-low signal indicates to an I/O device to place data onto the system data bus. MEMR 1 O IO Write command: This active-low signal indicates to an I/O device to place data onto the system data bus. MEMR 1 O MEMory Read command: This active-low signal indicates to a nemory mapped device to place data onto the system data bus. MEMW 1 O MEMory Write command: This active-low signal indicates to a memory mapped device that a write operation is in process on the system bus. CST6 1 I Chip Select 16-bit: This active-low feedback signal indicates that the device being accessed is a 16-bit device. This signal should be driven by external devices with an open collector or TRI-STATE® driver. RDY 1 I ReaDY: An external device may drive this signal inactive low to insert wait states and extend the external bus cycle. This	SA[25:0]	26	0	DRAN Interru	A accesses multiplex the row and column addresses for the DRAMs on the SA[12:1] pins. During upt Acknowledge cycles, the internal master interrupt controller's cascade line signals, CAS[2:0],				
Image: construction of the system of the	SD[15:0]	16	1/0						
IDW 1 O IO Write command: This active-low signal indicates to an I/O device that a write operation is in process on the system bus. MEMR 1 O MEMory Read command: This active-low signal instructs a memory mapped device to place data onto the system data bus. MEMW 1 O MEMory Read command: This active-low signal indicates to a memory mapped device to place data onto the system data bus. MEMW 1 O MEMory Write command: This active-low signal indicates to a memory mapped device that a write operation is in process on the system bus. CS16 1 I Chip Select 16-bit: This active-low feedback signal indicates that the device being accessed is a 16-bit device. This signal should be driven by external devices with an open collector or TRI-STATE® driver. RDY 1 I ReaDY: An external device may drive this signal inactive low to insert wait states and extend the external bus cycle. This signal should be driven with an open collector be TRI-STATE driven. TABLE 2-2. DMA Control Pin TABLE 2-2. DMA Control Pin DRQ6, DRQ4, DRQ2, DRQ0 4 I DMA ReQuest: A DRQn signal requests the internal DMA Controller to transfer data between the Requesting Device and memory. DACK6, DACK4, DACK6, DACK4, DACK0 4 O DMA ACKnowledge: When the CPU has relinquished control of the bus to a reques	BHE	1	0	transf	transferred. External 16-bit devices should use this signal to help them determine that a data byte is				
Image: Second System	IOR	1	0		ad command: This active-low signal instructs an I/O device to place data onto the system data				
Image: market index in the system data bus. MEMW 1 O MEMory Write command: This active-low signal indicates to a memory mapped device that a write operation is in process on the system bus. CS16 1 I Chip Select 16-bit: This active-low feedback signal indicates that the device being accessed is a 16-bit device. This signal should be driven by external devices with an open collector or TRI-STATE® driver. RDY 1 I ReaDY: An external device may drive this signal inactive low to insert wait states and extend the external bus cycle. This signal should be driven with an open collector be TRI-STATE driven. Symbol Pins Type Function DRQ6, DRQ4, DRQ4, DRQ4, DRQ0 4 I DMA ReQuest: A DRQn signal requests the internal DMA Controller to transfer data between the Requesting Device and memory. DACK6, DACK4, DACK0 4 O DMA ACKnowledge: When the CPU has relinquished control of the bus to a requesting DMA channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may	IOW 1 O IO Write command: This active-low signal indicates to an I/O device that a write operation is in putation.								
CS16 1 I Chip Select 16-bit: This active-low feedback signal indicates that the device being accessed is a 16-bit device. This signal should be driven by external devices with an open collector or TRI-STATE® driver. RDY 1 I ReaDY: An external device may drive this signal inactive low to insert wait states and extend the external bus cycle. This signal should be driven with an open collector be TRI-STATE driven. RDY 1 I ReaDY: An external device may drive this signal inactive low to insert wait states and extend the external bus cycle. This signal should be driven with an open collector be TRI-STATE driven. TABLE 2-2. DMA Control Pin TABLE 2-2. DMA Control Pin DRQ6, DRQ4, DRQ6, DRQ4, DRQ2, DRQ0 4 I DMA ReQuest: A DRQn signal requests the internal DMA Controller to transfer data between the Requesting Device and memory. DACK6, DACK4, DACK2, DACK0 4 O DMA ACKnowledge: When the CPU has relinquished control of the bus to a requesting DMA channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may									
Image: device. This signal should be driven by external devices with an open collector or TRI-STATE® driver. RDY I I ReaDY: An external device may drive this signal inactive low to insert wait states and extend the external bus cycle. This signal should be driven with an open collector be TRI-STATE driven. Symbol Pins Type TABLE 2-2. DMA Control Pin DRQ6, DRQ4, DRQ2, DRQ0 I I DMA ReQuest: A DRQn signal requests the internal DMA Controller to transfer data between the Requesting Device and memory. DACK6, DACK4, DACK4, DACK0 4 O DMA ACKnowledge: When the CPU has relinquished control of the bus to a requesting DMA channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may	MEMW	1	0	, , , , , , , , , , , , , , , , , , ,					
Symbol Pins Type TABLE 2-2. DMA Control Pin DRQ6, DRQ4, DRQ2, DRQ0 4 I DMA ReQuest: A DRQn signal requests the internal DMA Controller to transfer data between the Requesting Device and memory. DACK6, DACK4, DACK2, DACK0 4 O DMA ACKnowledge: When the CPU has relinquished control of the bus to a requesting DMA channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may	CS16	1	I						
Symbol Pins Type Function DRQ6, DRQ4, DRQ2, DRQ0 4 I DMA ReQuest: A DRQn signal requests the internal DMA Controller to transfer data between the Requesting Device and memory. DACK6, DACK4, DACK2, DACK0 4 O DMA ACKnowledge: When the CPU has relinquished control of the bus to a requesting DMA channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may	RDY	1	I						
DRQ6, DRQ4, DRQ2, DRQ0 4 1 DMA ReQuest: A DRQn signal requests the internal DMA Controller to transfer data between the Requesting Device and memory. DACK6, DACK4, DACK2, DACK0 4 0 DMA ACKnowledge: When the CPU has relinquished control of the bus to a requesting DMA channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may					TABLE 2-2. DMA Control Pin				
DRQ2, DRQ0 the Requesting Device and memory. DACK6, DACK4, DACK2, DACK0 4 O DMA ACKnowledge: When the CPU has relinquished control of the bus to a requesting DMA channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may	Symb	ol	Pins	Туре	Function				
DACK2, DACK0 channel, the appropriate active-low DACKn signal acknowledges the winning DRQn. TC/EOP 1 I/O Terminal Count/End Of Process: This signal may operate either as a terminal count output or a active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may	, ,		4	Ι	6 1				
active-low End of Process input. As TC, an active-high pulse occurs on this signal when the terminal count for any DMA channel has been reached. As EOP, an external device may			4	0					
	TC/EOP		1	1/0	terminal count for any DMA channel has been reached. As EOP, an external device may				

			TABLE 2-3. DRAM Control Pins			
Symbol Pins Type Function						
RAS[1:0]	2		Row Address Strobe: On the falling edge of these active-low signals, Bank 1 and Bank 0 respectively should latch in the row address off of SA [12:1]. If only one bank of DRAMs are supported, RASO will support that bank and RAS1 will be unused.			
CASH[1:0)] 2	0	Column Address Strobe (High Byte): These active-low signals indicate when the column access is being made to the high byte of DRAM Bank 1 and DRAM Bank 0 respectively. If only one bank of DRAMs are supported, CASH0 will support the high byte of that bank and CASH1 will be unused.			
CASL[1:0] 2	0	Column Address Strobe (Low Byte): These active-low signals indicate when the column access is being made to the low byte of DRAM Bank 1 and DRAM Bank 0, respectively. If only one bank of DRAMs are supported, CASL0 will support the low byte of that bank and CASL1 will be unused.			
WE	1	0	Write Enable: Active low signal for writing the data into the DRAM bank.			
DP[1:0]			DRAM Data Parity: DRAM data parity may be enabled or disabled; if disabled these two pins will be unused. Otherwise, for DRAM writes the NSC486SXF 's DRAM Controller will generate odd parity and drive the odd parity onto these two pins. For DRAM reads the NS486SXF 's DRAM Controller will read the values driven on these two pins and check it for odd parity in association with the appropriate data byte.			
			TABLE 2-4. Power Pins			
Symbol	nbol Pins Type Function					
V _{CC}	CC 10 I +3.3V or +5V power to core and I/O.					
V _{SS}	10	I	Ground to core and I/O.			
Symbol	Pin	s Type	TABLE 2-5. Reset Logic Pins Function			
RESET	RESET 1 0		RESET system output driver: This active high signal resets or initializes system peripheral logic duri power up or during a low line voltage outage.			
RESET	1	0	Inverse of RESET for peripherals requiring active low reset.			
PWGOOD	0 1	I	PoWer GOOD: This active-high (Schmitt trigger) input will cause a hardware reset to the NS486SXF whenver this input goes low. This pin will typically be driven by the power supply and PWGOOD will remain low until the power supply determines that stable and valid voltage levels have been achieved.			

				TABLE 2-6. Auxiliary Processor Interface Pins			
Symbol		Pins	Туре	Function			
EREQ/CS6/R	ITS	1	0	 This pin has three programmable options controlled by the Modem Signal Control Register (refer to the UART section): 1. External bus REQuest (active-low) to an auxiliary process. 2. Chip Select 6 (active-low) pin. 3. Request To Send. When low, this signal informs the MODEM or data set that the UART is ready to exchange data. The RTS output signal can be set to an active low by programming bit 2 (RTS) of the MODEM Control Register. A Master Reset operation sets this signal to its inactive (high) state. Loop mode operation holds this signal in its inactive state. 			
EACK/CS7/DSR		1	1/0	 70 This pin has three possible programmable options controlled by the Modem Signal Contr Register (refer to the UART section): 1. External bus ACKnowledge (active-low) from an auxiliary processor. 2. Chip Select 7 (active-low) pin. 3. Data Set Ready. When low, it indicates that the MODEM or data set is ready to link wit UART. The DSR signal is a MODEM status input whose condition can be tested by the reading bit 5 (DSR) of the MODEM Status Register. Bit 5 is the complement of the DSR signal. Bit 1 (DDSR) of the MODEM Status Register indicates whether the DSR input I changed state since the previous reading of the MODEM Status Register. Note: Whenever the DSR bit of the MODEM Status Register changes state, an interrupt is generated if the MOD Status Interrupt is enabled. 			
DRV/CS8/DTR		1	 O This pin has three possible programmable options controlled by the Modem Signal Cont Register (refer to the UART section): 1. DSP shared memory DRiVe control signal. 2. Chip Select 8 (active-low) pin. 3. Data Terminal Ready: When low, this signal informs the MODEM or data set that the l is ready to establish a communications link. The DTR output signal can be set to an a low by programming bit 0 (DTR) of the MODEM Control Register to a high level. A Ma Reset operation sets this signal to its inactive (high) state. Loop mode operation holds signal in its inactive state. 				
				TABLE 2-7. Test Pins			
Symbol Pin	ns	Туре		Function			
TEST 1		I/O	Reserve	ed for testing and development system support.			
				TABLE 2-8. Interrupt Control Pins			
Symbol Pir		Туре		Function			
NMI 1	1	Ι		askable Interrupt: This active-high signal will generate a non-maskable interrupt to the CPU wher ive high. Normally this signal is used to indicate a serious system error.			
INTA 1	1	0		upt Acknowledge: During each interrupt acknowledge cycle this signal will strobe low; it should be y external cascaded interrupt controllers.			
IRQ[5:0] 6	6	Ι	Interrupt ReQuests: These inputs are either rising edge or low-level sensitive interrupt requests, depending on the configuration of the internal interrupt controllers. These interrupt requests may also be programmed to support externally cascaded interrupt controller(s).				

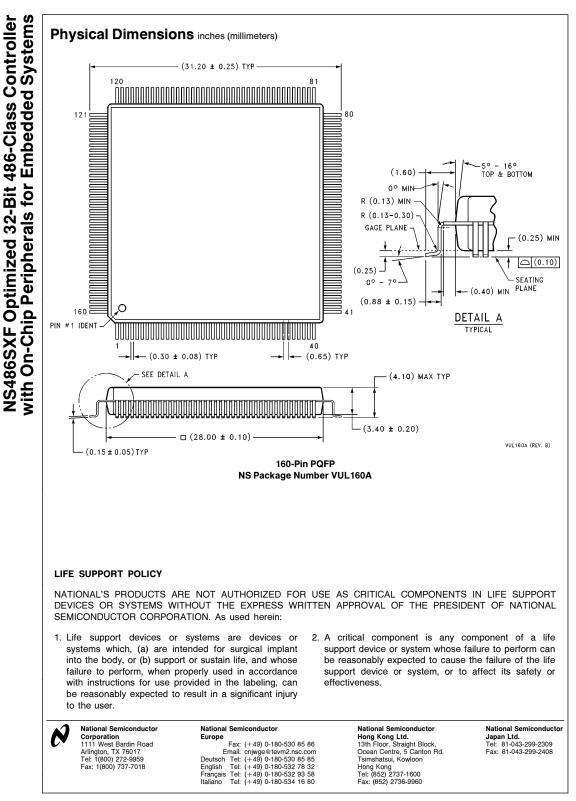
			TABLE 2-9. Real Time Clock Pins
Symbol	Pins	Туре	Function
RTCX1	1	Ι	Real Time Clock Crystal oscillator input: 32 kHz crystal.
RTCX2	1	0	Real Time Clock Crystal oscillator output: 32 kHz crystal.
Vbat	1	Ι	External + battery input for real time clock.
			TABLE 2-10. LCD Interface Pins
Symbol	Pins	Туре	Function
LCD[3:0]	4	0	Data Output Word to LCD, 1 = White, 0 = Blue/black.
CL2	1	0	Word CLock to LCD.
CL1	1	0	Row CLock to LCD.
CLF	1	0	Frame CLock to LCD.
			TABLE 2-11. Oscillator Pins
Symbol	Pins	Туре	Function
SYSCLK	1	0	SYStem CLocK: This clock output pin will either be driven with a signal half the frequency of the OSCX1 input clock frequency or the CPU's clock frequency, which is determined in the Power Management Control Register 1. The source selection for this signal is determined by bit 1 of the Power Management Control Register 3.
OSCX1	1	I	OSC illator Crystal 1 input: This pin should either be driven by a TTL oscillator or be connected to an external crystal circuit. This signal is the fundamental clock source for all clocked elements in the NS486SXF , except the Real-Time Clock, which has its own crystal pins.
OSCX2	1	0	OSC illator Crystal 2 output: This is the output side of the NS486SXF on-chip circuitry provided to support an external crystal circuit. If a TTL oscillator drives OSCX1, this pin should be a no connect.
			TABLE 2-12. IrDA/UART Pins
Symbol	Pins	Туре	Function
Тх	1	0	UART Transmit data: In IrDA mode this pin is the UART output encoded or the serial infrared link. Otherwise it is the transmit output of the 16550 UART.
Rx	1	I	UART Receive data: In IrDA mode this pin is routed through the serial infrared decoder. Otherwise, it is the receive input to the 16550.
UCLK	1	I/O	Uart CLocK: Output of programmable rate UART/MODEM clock. Typically used for the Infrared Modulator.

				TABLE 2-13. PCMCIA Pins		
Syml	ool	Pins	Type Function			
CD_RS1	-	1	0	CarD ReSeT: This active high signal resets the PCMCIA card during a soft-reset.		
IOIS16/WP		1	I	IO port IS 16 bits/Write Protect: When a PCMCIA card is configured as an IO card, this signal is asserted to indicate the currently addressed IO port is 16 bits wide. When a PCMCIA card is configured as a memory card, an active high signal indicates the card is currently write protected.		
BVD2/SPKR		1	I	Battery Voltage Detect bit 2/SPeaKeR output: When a PCMCIA card is configured as a memory card, this input along with BVD[1] will provide status information about the card's on-board battery condition. When a PCMCIA card is configured as an IO card, this pin will act as the audio output of the card to the system.		
BVD1/STSCNG 1		I	Battery Voltage Detect bit 1/STatuS ChaNGe output: When a PCMCIA card is configured as memory card, this input along with BVD[2] will provide status information about the card's of board battery state. When a PCMCIA card is configured as an I/O card, the status change s indicates one or more of the memory satus signal (BVD[2:1], WP, RDY or BSY) has changed states.			
V _{CC} _SEL		1	0	PCMCIA V_{CC} SELect: When this signal is high, the V_{CC} power to the PCMCIA card should be enabled.		
V _{PP} _SEL1, V _{PP} _SEL2		2	0			
GPI 1		I	$\label{eq:General Purpose Input: This signal is a general purpose input signal used with a PCMCIA card indicate a valid V_{PP} state, a pending card eject/insertion, or as an interrupt source.$			
CD2, CD	ī	2	I	Card Detect: Both signals are low when the PCMCIA card is correctly inserted.		
DIR		1	0	DIRection: Used to control the direction of the data line buffers to the PCMCIA interface.		
ENABLE		1	0	ENABLE PCMCIA: Enables the buffer drivers to the PCMCIA interface.		
REG		1	0	REG: PCMCIA card support.		
				TABLE 2-14. IEEE-1284 Port (ECP Mode)		
Symbol	Pins	Туре		Function		
PD[7:0]	8	1/0	Paralle	Pl Data: Bi-directional data pins transfer data and address information to and from the parallel port.		
SLIN	1	0/I		t IN put: Used in a closed-loop handshake with BUSY to transfer data or address information from st to the peripheral. Host driven.		
STB	1	0/I		TroBe: Driven high by the host while in ECP Mode. Asserted low by host to terminate ECP Mode turn link to Compatibility Mode. Host driven.		
AFD	1	0/1		atic FeeD: The host asserts this line low for flow control in the reverse direction. It is used in an cked handshake with ACK. Provides command information in the forward direction. Host driven. low.		
INIT	1	0/I		ize: When this signal is asserted low to place the data channel in the reverse direction, the eral is allowed to drive the data bus. Host driven. Active low.		
ACK	1	I/O		owledge: Used in closed-loop handshake with AFD to transfer data to the host. Peripheral device Active low.		
PE	1	I/O	Peripheral Error: Asserted low to acknowledge INIT, reverse request. Peripheral device drive.			
SLCT	1	1/0		T: Asserted high when selected or indicating an affirmative response for each respective ibility byte. Peripheral device drive. Active high.		
ERR	1	1/0		R : This input is asserted low by the peripheral to request host communications. Valid only in the d direction. Peripheral device drive. Active low.		
	1	1/0	forward direction. Peripheral device drive. Active low. BUSY: This is asserted low by the peripheral for flow control in the forward direction, de-asserted to acknowledge transfer or data or address completion. Peripheral device drive. Active low.			

			TABLE 2-15. Timer Pins				
Symbol	Pins	Туре	Function				
T0 1 I/O			 Programmer Timer pin 0: This Bidirectional pin may be selected to control one of the following four functions via bits 1–0 of the Timer I/O Control Register: 1. The GATE input into Timer 0. 2. The GATE input into Timer 1. 3. The OUT output from Timer 0. 4. The CLK input into Timer 1. 				
T1	1	1/0	 Programmable Timer pin 1: This Bidirectional pin may be selected to control one of the following four functions via bits 3–2 of the Timer I/O Control Register: 1. The GATE input into Timer 0. 2. The GATE input into Timer 1. 3. The OUT output from Timer 1. 4. The CLK input into Timer 0. 				
	T		TABLE 2-16. 3-Wire Serial I/O Pins				
Symbol	Pins	Туре	Function				
SO/DCD	1	1/0 1/0 1	 This pin has two possible programmable options controlled by the Modem Signal Control Register (refer to the UART section): 1. The serial data Output signal for MICROWIRE or the serial data I/O for Access.bus. 2. Data Carrier Detect: When low, this input signal indicates that the data carrier has been detected by the MODEM or data set. The DCD signal is a MODEM status input whose condition can be tested by the CPU reading bit 7 (DCD) of the MODEM Status Register. Bit 7 is the complement of the DCD signal. Bit 3 (DDCD) of the MODEM Status Register indicates whether the DCD input has changed state since the previous reading of the MODEM Status Register. DCD has no effect on the receiver. Note: Whenever the DCD bit of the MODEM Status Register changes state, an interrupt is generated if the MODEM Status Interrupt is enabled. 				
SI/CTS	1	I	 This pin has two possible programmable options controlled by the Modem Signal Control Register (refer to the UART section): 1. The Serial data Input signal for MICROWIRE. 2. Clear To Send: When low, this input signal indicates that the MODEM or data set is ready to exchange data. The CTS signal is a MODEM status input whose conditions can be tested by the CPU reading bit 4 (CTS) of the MODEM Status Register. Bit 4 is the complement of the CTS signal. Bit 0 (DCTS) of the MODEM Status Register indicates whether the CTS input has changed state since the previous reading of the MODEM Status Register. CTS has no effect on the Transmitter. Note: Whenever the CTS bit of the MODEM Status Register changes state, an interrupt is generated if the MODEM Status Interrupt is enabled. 				
SCLK/RĪ	1	0	 This pin has two possible programmable options controlled by the Modem Signal Control Register (refer to the UART section): 1. The Serial CLocK signal for MICROWIRE and Access.bus. 2. Ring Indicator. When low, this input signal indicates that a telephone ringing signal has been received by the MODEM or data set. The RI signal is a MODEM status input whose condition can be tested by the CPU reading bit 6 (RI) of the MODEM Status Register. Bit 6 is the complement of the R signal. Bit 2 (TERI) of the MODEM Status Register indicates whether the RI input signal has changed from a low to high state since the previous reading of the MODEM Status Register. Note: Whenever the CTS bit of the MODEM Status Register changes state, an interrupt is generated if the MODEM Status Interrupt is enabled. Note: Whenever the RI bit of the MODEM Status Register changes from a high to a low state, an interrupt is generated if the MODEM Status Interrupt is enabled. 				

				TABLE 2-17. Gen	eral Purpose Chip Select Pins	
Symbol	Pins	Туре			Function	
CS0	1	0	Chip Select 0: kBytes of men		d as the chip select for the system boot R	OM. If defaults to the upper 64
CS[5:1]	<u>S[5:1]</u> 5 I/O		which are use	d for glue-less con	be programmed to be either memory or I nection to external peripherals. When the Card Enable inputs 1 and 2 (CET and CE2	PCMCIA Controller is enabled
			тл	ABLE 2-18. Summ	ary of Reconfigurable I/O Pins	
Symbol			Pins	Туре	Pin #	Original Function
REG			1	I/O	79	PCMCIA
ENABLE			1	I/O	78	PCMCIA
DIR			1	I/O	77	PCMCIA
GPI			1	I/O	72	PCMCIA
V _{PP} _SEL2			1	I/O	71	PCMCIA
V _{PP} _SEL1			1	I/O	70	PCMCIA
V _{CC} _SEL			1	1/0	69	PCMCIA
CD_RST			1	I/O	68	PCMCIA
CLF			1	1/0	48	LCD
CL2			1	I/O	50	LCD
CL1			1	I/O	49	LCD
LCD	[3:0]		4	I/O	51, 52, 53, 54	LCD
PD	7:0]		8	1/0	81, 82, 83, 85, 86, 88, 89, 90	ECP
Rx			1	I/O	58	UART
UCLK			1	I/O	59	UART
CS	1		1/0	114	CS4	
CS	CS [3] 1		I/O	115	CS3	
CS	2]		1	1/0	116	CS2
<u>CS [1]</u>			1	1/0	117	CS1

These 29 pins, typically used for various I/O peripheral purposes, as defined in the above tables, can be reconfigured for use as general purpose I/O pins if the normally defined I/O function is not required.



National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications